

CELCON[®] LU02

CELCON®

Celcon® acetal copolymer grade LU02 is UV stabilized material displaying a reduced gloss over standard UV acetal grades.

Product information			
Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 11469
Rheological properties			
Melt volume-flow rate	20	cm ³ /10min	ISO 1133
Temperature	190		
Load	2.16	•	
Moulding shrinkage, parallel Moulding shrinkage, normal	1.9 1.6		ISO 294-4, 2577 ISO 294-4, 2577
Moulding Shinkage, normal	1.0	70	130 294-4, 2377
Typical mechanical properties			
Tensile modulus	2530	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min		MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	9		ISO 527-1/-2
Nominal strain at break	11		ISO 527-1/-2
Flexural modulus Flexural stress at 3.5%	2500 67	MPa	ISO 178 ISO 178
Charpy notched impact strength, 23°C		kJ/m ²	ISO 178 ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m ²	ISO 179/1eA
Poisson's ratio	0.38 ^[C]		
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	167	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa		°C	ISO 75-1/-2
Physical/Other properties			
Density	1390	kg/m³	ISO 1183
Denoty	1000	Ng/III	
Injection			
Drying Recommended	no		
Drying Temperature	100		
Drying Time, Dehumidified Dryer	3 - 4		
Processing Moisture Content	≤0.2		
Melt Temperature Optimum	190 180		
Min. melt temperature Max. melt temperature	195		
Screw tangential speed	≤0.3		
Mold Temperature Optimum		°C	
Min. mould temperature		°C	
Max. mould temperature	105		
Hold pressure range	60 - 120		
Back pressure	4	MPa	

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Characteristics

Processing Delivery form Special characteristics Injection Moulding Pellets U.V. stabilised or stable to weather, Reduced gloss

Additional information

Injection molding

Preprocessing

Drying is recommended for low gloss grades of Celcon® and Hostaform® acetal copolymers. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

Processing

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Use a slow injection speed until material passes through the gate.

Melt Temperature: Preferred range 180-195 C (~356-~383 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 80-105 C especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. In general, mold surface temperatures lower than 82 C (180 F) may produce a hazy surface or a surface with flow lines, pits and other included defects.

Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

Processing Notes

Pre-Drying

Predrying is required before processing to ensure a low gloss finish.

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Automotive

OEM Honda Nissan ADDITIONAL INFORMATION Color approved Color approved

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